



Board Stack up:

Layer	Thickness(mils)
Top	1.35 (1 oz copper)
Dielectric	4.3
GND1	1.35 (1 oz copper)
Dielectric	18
ROUTING1	1.35 (1 oz copper)
Dielectric	7.65
GND2	1.35 (1 oz copper)
Dielectric	18
PWB	1.35 (1 oz copper)
Dielectric	4.3
Bottom	1.35 (1 oz copper)

board material = FR4
 overall board dimensions = 11.49 in x 6.1in
 soldermask color = green
 silkscreen color = white
 total thickness 60.35mils









